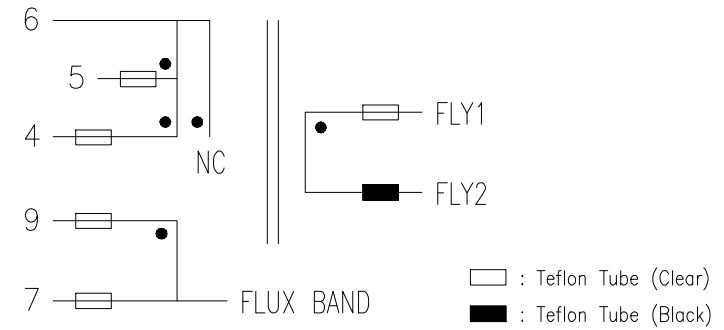
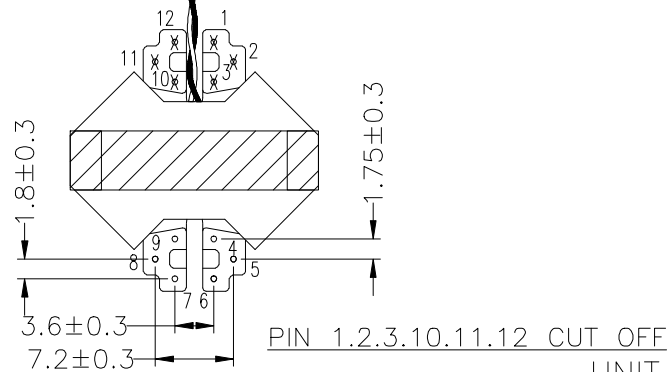
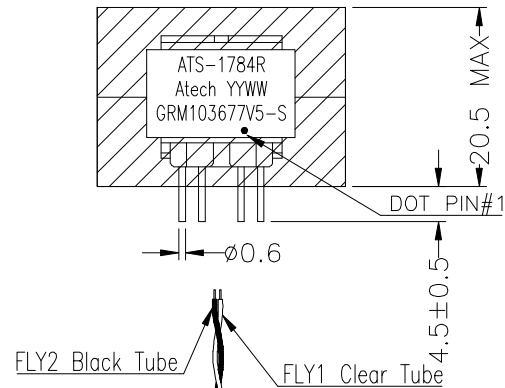
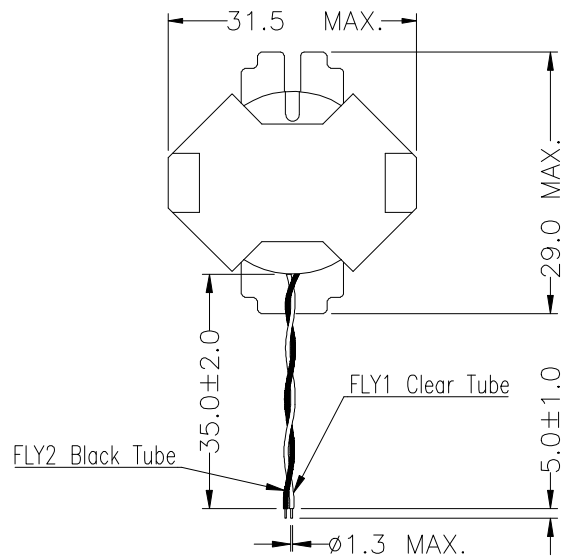


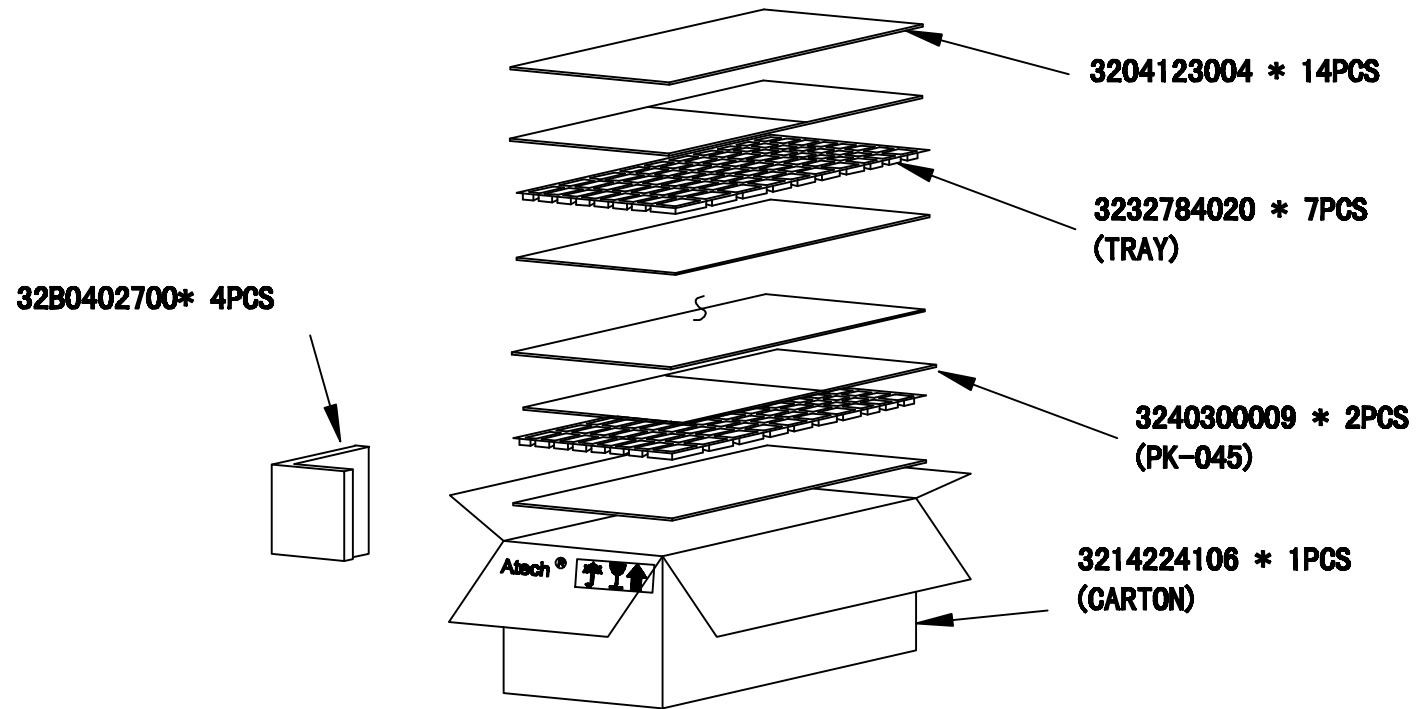


* RoHS COMPLIANTE

ELECTRICAL CHARACTERISTICS :

- DCR : PIN 4-6 = 270mΩ MAX.
PIN 7-9 = 110mΩ MAX.
FLY1 - FLY2 = 18mΩ MAX.
- INDUCTANCE (@10kHz, 1.0Vrms) PIN 4-6 = 900uH ±7%
- LEAKAGE INDUCTANCE (@10kHz, 1.0Vrms) :
PIN 4-6 (PIN 7-9, FLY1-FLY2 SHORT) = 12uH MAX.
- TURN RATIO : (@100kHz, 0.1Vrms)
PIN 4-5 : 5-6 = 1.0 ±2%
PIN 4-6 : 9-7 = 3.33 ±2%
PIN 4-6 : FLY1-FLY2 = 6.66 ±2%
- HI-POT : PIN 4.9.7 - FLY1 (@3000VAC, 2mA, 60SEC.)

								TITLE TRANSFORMER
								DWG. NO. ATS-1784R
	RELEASE	03/30/2018	SHIRLEY	RONAN	RONAN	UNITS: M/M	SAFETY	SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	DRAW SHIRLEY
REVISIONS						03/30/2018		



ONE TRAY: 30PCS
ONE CARTON: 7TRAYS(210PCS)

紙箱的兩側各放一塊3240300010珍珠棉
(珍珠棉*2PCS)

每盤產品上各放二塊3240300009珍珠棉(PK-045*14PCS),
再上下各一塊PK-016 (PK-016*14PCS)

紙箱外四棱角處用4PCS*32B0402700做保護

								TITLE PACKING	
								DWG. NO. 968S178400	
	RELEASE	04/11/2018	SHIRLEY	JOAN	JOAN	UNITS: M/M	SAFETY		SHEET 1 of 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:		DRAW Shirley
REVISIONS						04/11/2018			



Resistance to soldering heat (wave soldering)



Resistance to soldering heat (wave soldering) referring to the terminals

Key	Par.	Profile feature	Pb free Process
T.1	T_{sb}	Final Preheat Temperature	150°C
T.2	t pre-heat	Pre-heating time (T_{room} to T_{sb})	180sec
T.3	d_T/d_t up	Ramp-Up Rate (T_{sb} to T_p)	180°C/sec
T.4	T_p	Peak Temperature T_p	255°C ~ 265°C
T.5	t contact	Contact Time at Peak	10sec (5sec x wave)
T.6	d_T/d_t down	Ramp-Down Rate	5°C/sec
Failure criteria concerning quality of the soldering termination acc. to the IPC-A-610D			